

RoHS

HALOGEN

FREE



# **Precision Monolithic Quad SPST CMOS Analog Switches**

#### **DESCRIPTION**

The DG411 series of monolithic guad analog switches was designed to provide high speed, low error switching of precision analog signals. Combining low power (0.35 µW) with high speed (t<sub>ON</sub>: 110 ns), the DG411 family is ideally suited for portable and battery powered industrial and military applications.

To achieve high-voltage ratings and superior switching performance, the DG411 series was built on Vishay Siliconix's high voltage silicon gate process. An epitaxial layer prevents latchup.

Each switch conducts equally well in both directions when on, and blocks input voltages up to the supply levels when off.

The DG411, DG412 respond to opposite control logic as shown in the Truth Table. The DG413 has two normally open and two normally closed switches.

#### **FEATURES**

- Halogen-free according to IEC 61249-2-21 **Definition**
- 44 V supply max. rating
- ± 15 V analog signal range
- On-resistance  $R_{DS(on)}$ : 25  $\Omega$
- Fast switching t<sub>ON</sub>: 110 ns
- Ultra low power P<sub>D</sub>: 0.35 μW
- TTL, CMOS compatible
- Single supply capability
- Compliant to RoHS Directive 2002/95/EC

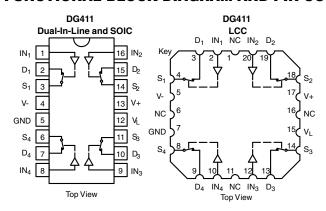
#### **BENEFITS**

- Widest dynamic range
- Low signal errors and distortion
- Break-bevor-make switching action
- Simple interfacing

#### **APPLICATIONS**

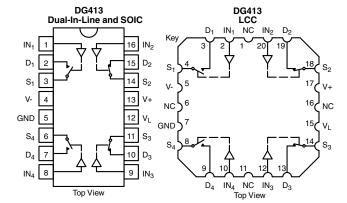
- Precision automatic test equipment
- Precision data acquisition
- Communication systems
- Battery powered systems
- Computer peripherals

#### **FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION**



TRUTH TABLE					
Logic	DG411	DG412			
0	ON	OFF			
1	OFF	ON			

Logic "0" ≤ 0.8 V Logic "1" ≥ 2.4 V



TRUTH TABLE					
Logic	SW <sub>1</sub> , SW <sub>4</sub>	SW <sub>2</sub> , SW <sub>3</sub>			
0	OFF	ON			
1	ON	OFF			

Logic "0" ≤ 0.8 V Logic "1" ≥ 2.4 V

Document Number: 70050 S11-1185-Rev. G, 13-Jun-11



ORDERING INFORMATION			
Temp. Range	Package	Part Number	
		DG411DJ DG411DJ-E3	
	16-pin plastic DIP	DG412DJ DG412DJ-E3	
		DG413DJ DG413DJ-E3	
- 40 °C to 85 °C		DG411DY DG411DY-E3 DG411DY-T1 DG411DY-T1-E3	
	16-pin narrow SOIC	DG412DY DG412DY-E3 DG412DY-T1 DG412DY-T1-E3	
		DG413DY DG413DY-E3 DG413DY-T1 DG413DY-T1-E3	
		DG411DQ-E3 DG411DQ-T1-E3	
	16-pin TSSOP	DG412DQ-E3 DG412DQ-T1-E3	
		DG413DQ-E3 DG413DQ-T1-E3	

ABSOLUTE MAXIMUM RATINGS				
Parameter		Limit	Unit	
V + to V -		44		
GND to V -		25		
$V_L$		(GND - 0.3) to (V+) + 0.3	V	
Digital Inputs <sup>a</sup> , V <sub>S</sub> , V <sub>D</sub>		(V-) -2 to (V+) + 2 or 30 mA, whichever occurs first		
Continuous Current (Any terminal)		30	mA	
Peak Current, S or D (Pulsed at 1 ms,	10 % duty cycle)	100	IIIA	
Storage Temperature	(AK, AZ suffix)	- 65 to 150	°C	
Storage remperature	(DJ, DY suffix)	- 65 to 125	]	
	16-pin plastic DIP <sup>c</sup>	470		
Device Dissipation (Dealers)b	16-pin narrow SOIC <sup>d</sup>	600	m\\/	
Power Dissipation (Package) <sup>b</sup>	16-pin CerDIP <sup>e</sup>	900	mW	
	LCC-20 <sup>e</sup>	900		

#### Notes:

- a. Signals on  $S_X$ ,  $D_X$ , or  $IN_X$  exceeding V + or V will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- b. All leads welded or soldered to PC board.
- c. Derate 6 mW/°C above 25 °C.
- d. Derate 7.6 mW/°C above 75 °C.
- e. Derate 12 mW/°C above 75 °C.



SPECIFICATIONS	<b>)</b>	T . A . IIII				***		***	1
		Test Conditions Unless Specified				uffix o 125 °C		uffix to 85 °C	
		V + = 15 V, V - = - 15 V				120 0			
Parameter	Symbol	$V_L = 5 \text{ V}, V_{IN} = 2.4 \text{ V}, 0.8 \text{ V}^f$	Temp.b	Typ. <sup>c</sup>	Min. <sup>d</sup>	Max. <sup>d</sup>	Min. <sup>d</sup>	Max. <sup>d</sup>	Unit
Analog Switch									
Analog Signal Range <sup>e</sup>	$V_{ANALOG}$		Full		- 15	15	- 15	15	V
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V += 13.5  V, V -= -13.5  V $I_S = -10 \text{ mA}, V_D = \pm 8.5 \text{ V}$	Room Full	25		35 45		35 45	Ω
Switch Off Leakage	I <sub>S(off)</sub>	V + = 16.5, V - = - 16.5 V	Room Full	± 0.1	- 0.25 - 20	0.25 20	- 0.25 - 5	0.25 5	
Current	I <sub>D(off)</sub>	$V_D = \pm 15.5 \text{ V}, V_S = \pm 15.5 \text{ V}$	Room Full	± 0.1	- 0.25 - 20	0.25 20	- 0.25 - 5	0.25 5	nA
Channel On Leakage Current	I <sub>D(on)</sub>	V + = 16.5  V, V - = -16.5  V $V_S = V_D = \pm 15.5 \text{ V}$	Room Full	± 0.1	- 0.4 - 40	0.4 40	- 0.4 - 10	0.4 10	
Digital Control									
Input Current, V <sub>IN</sub> Low	Ι <sub>ΙL</sub>	V <sub>IN</sub> under test = 0.8 V	Full	0.005	- 0.5	0.5	- 0.5	0.5	μΑ
Input Current, V <sub>IN</sub> High	I <sub>IH</sub>	$V_{IN}$ under test = 2.4 V	Full	0.005	- 0.5	0.5	- 0.5	0.5	μΛ
Dynamic Characteristics	5								
Turn-On Time	t <sub>ON</sub>	$R_L = 300 \ \Omega, \ C_L = 35 \ pF$	Room Full	110		175 240		175 220	
Turn-Off Time	t <sub>OFF</sub>	$V_S = \pm 10 \text{ V}$ , see figure 2	Room Full	100		145 160		145 160	ns
Break-Before-Make Time Delay	t <sub>D</sub>	DG413 only, $V_S = 10 \text{ V}$ R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF	Room	25					
Charge Injection	q	$V_g = 0 \text{ V, } R_g = 0 \Omega$ $C_L = 10 \text{ nF}$	Room	5					рС
Off Isolation <sup>e</sup>	OIRR	$R_1 = 50 \Omega$ , $C_1 = 5 pF$ ,	Room	68					
Channel-to-Channel Crosstalk <sup>e</sup>	X <sub>TALK</sub>	f = 1 MHz	Room	85					dB
Source Off Capacitance <sup>e</sup>	C <sub>S(off)</sub>		Room	9					
Drain Off Capacitance <sup>e</sup>	C <sub>D(off)</sub>	f = 1 MHz	Room	9					pF
Channel On Capacitance <sup>e</sup>	C <sub>D(on)</sub>	1 – 1 WH2	Room	35					Pi
Power Supplies	<u> </u>						I.	I.	
Positive Supply Current	l+		Room Full	0.0001		1 5		1 5	
Negative Supply Current	l-	V + = 16.5 V, V - = - 16.5 V	Room Full	- 0.0001	- 1 - 5		- 1 - 5		μΑ
Logic Supply Current	ΙL	$V_{IN} = 0 V \text{ or } 5 V$	Room Full	0.0001		1 5		1 5	μΑ
Ground Current	I <sub>GND</sub>		Room Full	- 0.0001	- 1 - 5		- 1 - 5		



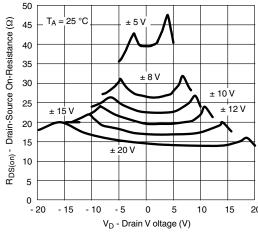
SPECIFICATIONS <sup>a</sup> (for Unipolar Supplies)									
Parameter	Symbol	Test Conditions Unless Specified	Temp.b	Temp. <sup>b</sup> Typ. <sup>c</sup>		A Suffix - 55 °C to 125 °C		uffix to 85 °C	Unit
rarameter	Cymbol	V += 12 V, V -= 0 V $V_L = 5 V, V_{IN} = 2.4 V, 0.8 V^f$	Temp.	Typ.	Min. <sup>d</sup>	Max. <sup>d</sup>	Min. <sup>d</sup>	Max. <sup>d</sup>	
Analog Switch									
Analog Signal Range <sup>e</sup>	$V_{ANALOG}$		Full			12		12	٧
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V += 10.8  V, $I_S = -10 \text{ mA}, V_D = 3 \text{ V}, 8 \text{ V}$	Room Full	40		80 100		80 100	Ω
Dynamic Characteristics									
Turn-On Time	t <sub>ON</sub>	$R_L = 300 \ \Omega, \ C_L = 35 \ pF$	Room Hot	175		250 400		250 315	
Turn-Off Time	t <sub>OFF</sub>	$V_S = 8 V$ , see figure 2	Room Hot	95		125 140		125 140	ns
Break-Before-Make Time Delay	t <sub>D</sub>	DG413 only, $V_S = 8 V$ $R_L = 300 Ω$ , $C_L = 35 pF$	Room	25					
Charge Injection	Q	$V_g = 6 \text{ V}, R_g = 0 \Omega, C_L = 10 \text{ nF}$	Room	25					рС
Power Supplies									
Positive Supply Current	l+		Room Hot	0.0001		1 5		1 5	
Negative Supply Current	l-	V . 12 E V V . 0 V oz E V	Room Hot	- 0.0001	- 1 - 5		- 1 - 5		
Logic Supply Current	ΙL	$V + = 13.5 \text{ V}, V_{IN} = 0 \text{ V or } 5 \text{ V}$	Room Hot	0.0001		1 5		1 5	μΑ
Ground Current	I <sub>GND</sub>		Room Hot	- 0.0001	- 1 - 5		- 5		

#### Notes:

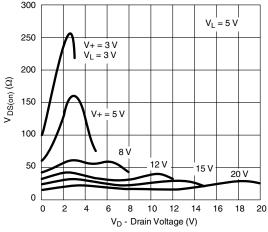
- a. Refer to process option flowchart.
- b.Room = 25 °C, Full = as determined by the operating temperature suffix.
- c. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- d. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- e.Guaranteed by design, not subject to production test.
- f. V<sub>IN</sub> = input voltage to perform proper function.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



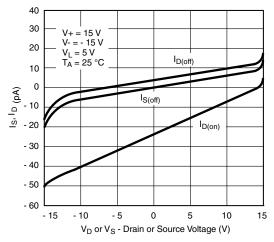
On-Resistance vs. V<sub>D</sub> and Power Supply Voltage



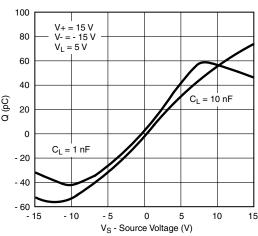
On-Resistance vs. V<sub>D</sub> and Unipolar Supply Voltage



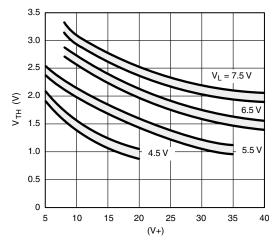
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



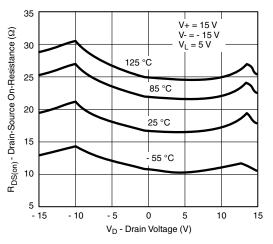
Leakage Current vs. Analog Voltage



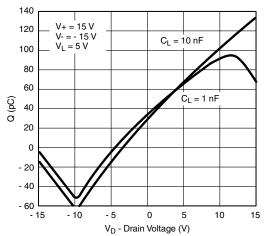
Charge Injection vs. Analog Voltage



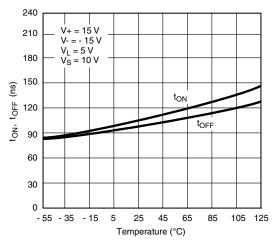
Input Switching Threshold vs. Supply Voltage



I<sub>D</sub>, I<sub>S</sub> Leakages vs. Temperature



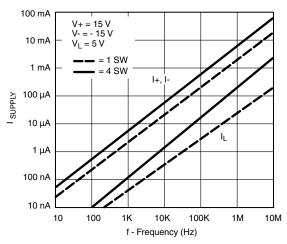
Charge Injection vs. Analog Voltage



Switching Time vs. Temperature

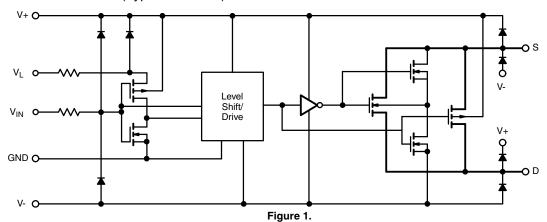
# VISHAY.

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Supply Current vs. Input Switching Frequency

### **SCHEMATIC DIAGRAM** (Typical Channel)



#### **TEST CIRCUITS**

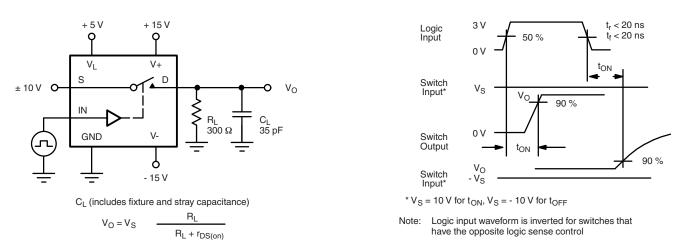
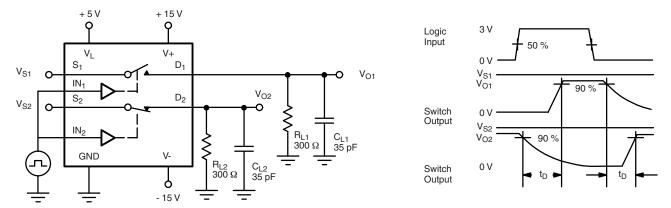


Figure 2. Switching Time

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#### **TEST CIRCUITS**



C<sub>L</sub> (includes fixture and stray capacitance)

Figure 3. Break-Before-Make (DG413)

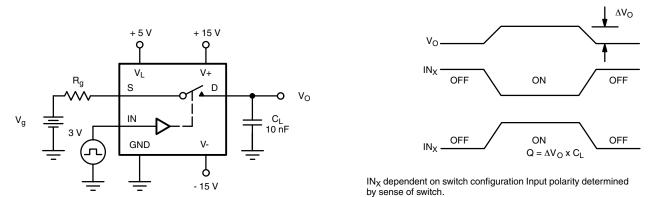


Figure 4. Charge Injection

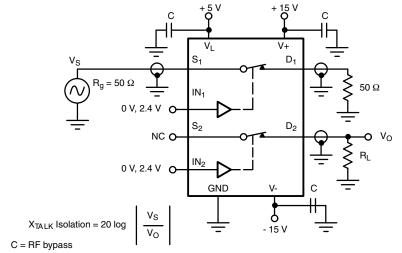


Figure 5. Crosstalk



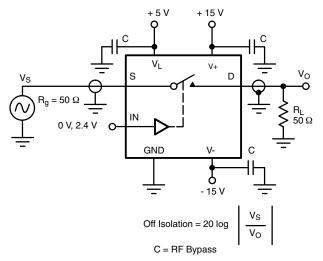


Figure 6. Off Isolation

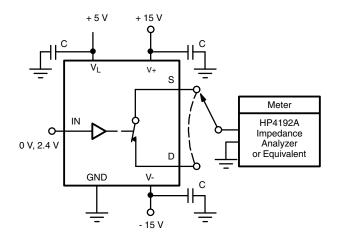


Figure 7. Source/Drain Capacitances

#### **APPLICATIONS**

#### **Single Supply Operation:**

The DG411, DG412, DG413 can be operated with unipolar supplies from 5 V to 44 V. These devices are characterized and tested for unipolar supply operation at 12 V to facilitate the majority of applications. In single supply operation, V+ is tied to  $V_L$  and  $V_T$  is tied to 0  $V_T$ . See Input Switching Threshold vs. Supply Voltage curve for V<sub>I</sub> versus input threshold requirments.

#### **Summing Amplifier**

When driving a high impedance, high capacitance load such as shown in figure 8, where the inputs to the summing amplifier have some noise filtering, it is necessary to have shunt switches for rapid discharge of the filter capacitor, thus preventing offsets from occurring at the output.

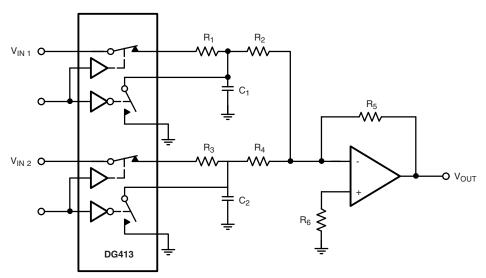
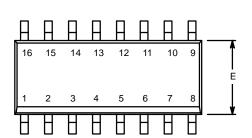


Figure 8. Summing Amplifier

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppq?70050.

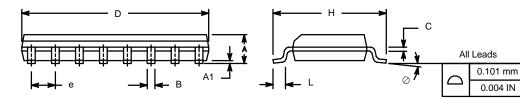


SOIC (NARROW): 16-LEAD JEDEC Part Number: MS-012



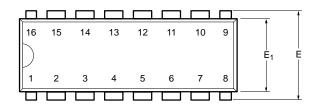
	MILLIMETERS		INC	HES			
Dim	Min	Max	Min	Max			
Α	1.35	1.75	0.053	0.069			
A <sub>1</sub>	0.10	0.20	0.004	0.008			
В	0.38	0.51	0.015	0.020			
С	0.18	0.23	0.007	0.009			
D	9.80	10.00	0.385	0.393			
Е	3.80	4.00	0.149	0.157			
е	1.27	BSC	0.050	BSC			
Н	5.80	6.20	0.228	0.244			
L	0.50	0.93	0.020	0.037			
0	0°	8°	0°	8°			
ECN: S-0	ECN: S-03946—Rev. F. 09-Jul-01						

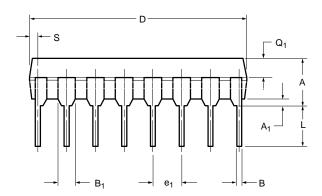
DWG: 5300

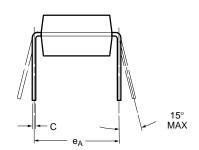




PDIP: 16-LEAD







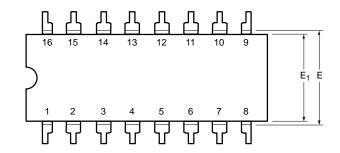
	MILLIN	IETERS	INC	HES			
Dim	Min	Max	Min	Max			
Α	3.81	5.08	0.150	0.200			
A <sub>1</sub>	0.38	1.27	0.015	0.050			
В	0.38	0.51	0.015	0.020			
B <sub>1</sub>	0.89	1.65	0.035	0.065			
С	0.20	0.30	0.008	0.012			
D	18.93	21.33	0.745	0.840			
E	7.62	8.26	0.300	0.325			
E <sub>1</sub>	5.59	7.11	0.220	0.280			
e <sub>1</sub>	2.29	2.79	0.090	0.110			
e <sub>A</sub>	7.37	7.87	0.290	0.310			
L	2.79	3.81	0.110	0.150			
Q <sub>1</sub>	1.27	2.03	0.050	0.080			
S	0.38	1.52	.015	0.060			
ECN: S-0	ECN: S-03946—Rev. D, 09-Jul-01						

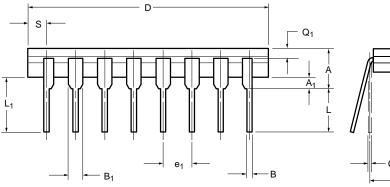
DWG: 5482

Document Number: 71261 www.vishay.com 06-Jul-01



#### **CERDIP: 16-LEAD**





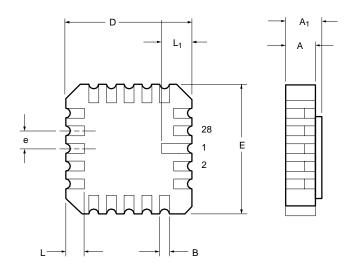
	<u> </u>
<b>//</b>	<b># \</b>
C	e <sub>A</sub>

	MILLIMETERS INC		INC	HES			
Dim	Min	Max	Min	Max			
Α	4.06	5.08	0.160	0.200			
A <sub>1</sub>	0.51	1.14	0.020	0.045			
В	0.38	0.51	0.015	0.020			
B <sub>1</sub>	1.14	1.65	0.045	0.065			
С	0.20	0.30	0.008	0.012			
D	19.05	19.56	0.750	0.770			
E	7.62	8.26	0.300	0.325			
E <sub>1</sub>	6.60	7.62	0.260	0.300			
e <sub>1</sub>	2.54	BSC	0.100	BSC			
e <sub>A</sub>	7.62 BSC		0.300	BSC			
L	3.18	3.81	0.125	0.150			
L <sub>1</sub>	3.81	5.08	0.150	0.200			
$Q_1$	1.27	2.16	0.050	0.085			
S	0.38	1.14	0.015	0.045			
∞	0°	15°	0°	15°			
ECN: S-0	ECN: S-03946—Rev. G, 09-Jul-01						

Document Number: 71282 www.vishay.com 03-Jul-01 www.vishay.com



#### **20-LEAD LCC**

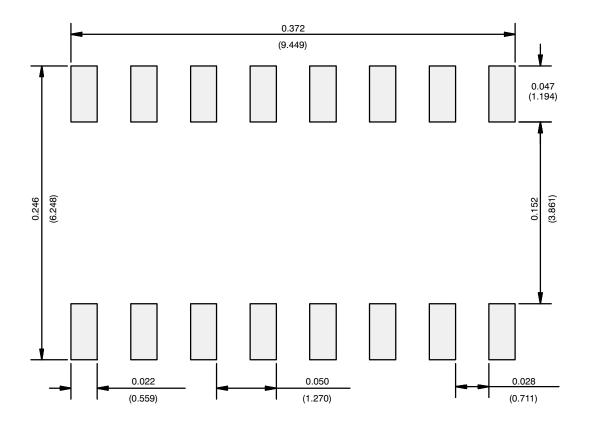


	MILLIMETERS		INC	HES			
Dim	Min	Max	Min	Max			
Α	1.37	2.24	0.054	0.088			
A <sub>1</sub>	1.63	2.54	0.064	0.100			
В	0.56	0.71	0.022	0.028			
D	8.69	9.09	0.342	0.358			
E	8.69	9.09	0.442	0.358			
е	1.27 BSC		0.050	BSC			
L	1.14	1.40	0.045	0.055			
L <sub>1</sub>	1.96	2.36	0.077	0.093			
ECN: S-03	ECN: S-03946—Rev. B, 09-Jul-01						

DWG: 5321



#### **RECOMMENDED MINIMUM PADS FOR SO-16**



Recommended Minimum Pads Dimensions in Inches/(mm)

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Vishay

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Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

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